

Bumped GaAs SP3T Switch for WLAN 2.4 - 2.5 GHz

Features

- 802.11b/g and Bluetooth Applications
- Insertion Loss: 0.60 dB typical
- Isolation:

31 dB typical (R_X Path) 22 dB typical (T_X / BT paths)

- Flip-chip configuration
- RoHS* Compliant

Description

The MASW-008902-000DIE is a bumped single band GaAs pHEMT MMIC SP3T switch. Typical applications are for single band 2.4 GHz WLAN (802.11 b/g) and Bluetooth applications.

The MASW-008902-000DIE delivers high isolation, low insertion loss, and high linearity at 2.4 - 2.5 GHz.

The MASW-008902-000DIE is fabricated using a 0.5 micron gate length GaAs pHEMT process. The process features full passivation for performance and reliability. This die features SnAg (2.5%) solder bumps for WLCSP applications.

Ordering Information ^{1,2}

Commitment to produce in volume is not guaranteed.

| Part Number | Package |
|--------------------|----------------------------|
| MASW-008902-000DIE | Separated Die on Grip Ring |
| MASW-008902-000D3K | Die in 3000 piece reel |
| MASW-008902-001SMB | Sample Board SP3T |

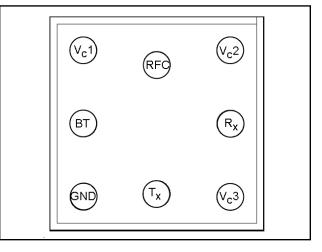
1. Die quantity varies.

1

2. Die on Grip Ring not available with orientation mark.

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Die Bump Pad Layout (bump side up)



Die Bump Pad Configuration

| Name | Description | | |
|------------------|--|--|--|
| V _c 1 | Voltage Control 1 | | |
| ВТ | Blue Tooth T _x /R _x Port | | |
| GND | Ground | | |
| T _x | 2.5 GHz T _x Port | | |
| V _c 3 | Voltage Control 3 | | |
| R _x | 2.5 GHz R _x Port | | |
| Vc2 | Voltage Control 2 | | |
| RFC | Antenna Port | | |

Absolute Maximum Ratings ^{3,4}

| Parameter | Absolute Maximum | |
|---------------------------|------------------|--|
| Input Power @ 3 V Control | +32 dBm | |
| Input Power @ 5 V Control | +35 dBm | |
| Operating Voltage | +8 volts | |
| Operating Temperature | -40°C to +85°C | |
| Storage Temperature | -65°C to +150°C | |

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

4. M/A-COM Technology does not recommend sustained operation near these survivability limits.

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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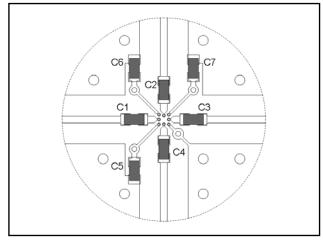
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Electrical Specifications⁵: $T_A = 25^{\circ}C$, $Z_0 = 50 \Omega$, $V_C = 0/3V$, $P_{IN} = 0 \text{ dBm}$

| Parameter | Test Conditions | | Min. | Тур. | Max. |
|-----------------|---|---|----------------|----------------------|------|
| Insertion Loss | RFC to $T_x/R_x/BT$, 2.4 GHz | RFC to T _x /R _x /BT, 2.4 GHz dB | | 0.60 | 0.75 |
| Isolation | RFC to T _x , 2.4 GHz RFC to R _x , 2.4 GHz RFC to BT, 2.4 GHz | dB | 20 30 20 | 23.5 31.0 21.0 | |
| Return Loss | 2.4 - 2.5 GHz | dB | _ | 15 | |
| IP3 | RF to $T_x/R_x/BT$, 2.4 GHz, 20 dBm Total Power, 1 MHz Spacing | dBm | — | 55 | _ |
| Input P1dB | RF to T _x , 2.4 - 2.5 GHz RF to R _x , 2.4 - 2.5 GHz RF to BT, 2.4 - 2.5 GHz | dBm | | 32 28 32 | |
| Harmonics | RF to T _x , 2.4 - 2.5 GHz, 20 dBm | dBm | | -75 | |
| Switching Speed | 50% control to 90% RF 50% control to 10% RF | ns | | 165 25 | |
| Control Current | V _c = 3 V | μA | — | <1 | 10 |

5. External blocking capacitors on all RF ports.

Recommended PCB Configuration



Parts List

| Part | Value | Case Style |
|---------|---------|------------|
| C1 - C4 | 39 pF | 0402 |
| C5 - C7 | 1000 pF | 0402 |

Truth Table 6,7,8

| V _c 1 | V _c 2 | V _c 3 | RFC-BT | RFC-T _x | RFC-R _x |
|------------------|------------------|------------------|--------|--------------------|--------------------|
| 1 | 0 | 0 | On | Off | Off |
| 0 | 1 | 0 | Off | On | Off |
| 0 | 0 | 1 | Off | Off | On |

6. For positive voltage control, external DC blocking capacitors are required on all RF ports.

- Differential voltage, V(state 1) V(state 0), must be +2.7 V minimum and must not exceed +5 V.
- 8. $0 = 0 \pm 0.3$ V, 1 = +2.7 V to +5 V.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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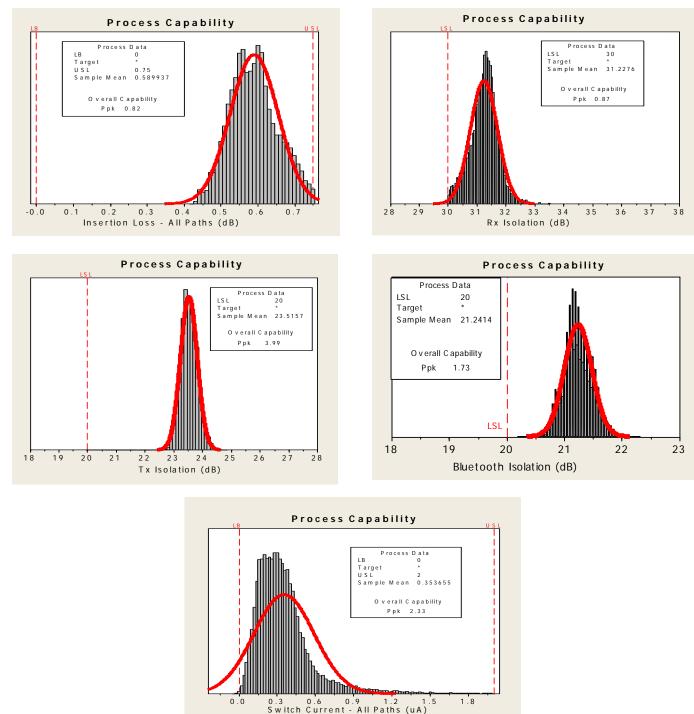
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Product Consistency Distribution Charts⁹ (on wafer RF test)



- 9. Represents >50 wafers, tested per electrical specifications: Freq. = 2.4 GHz, $T_A = 25^{\circ}C$, $Z_0 = 50 \Omega$, $V_C = 0/3V$, $P_{IN} = 0 dBm$
- 3

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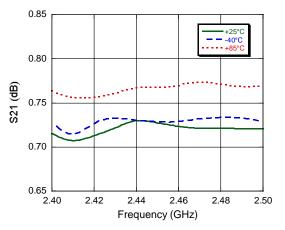
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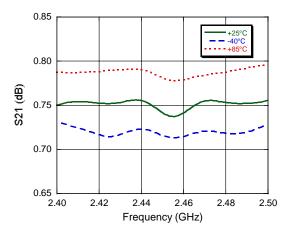
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Typical Performance Curves (plots = chip on board assembly)

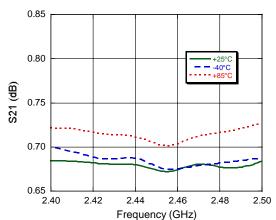
T_x Insertion Loss

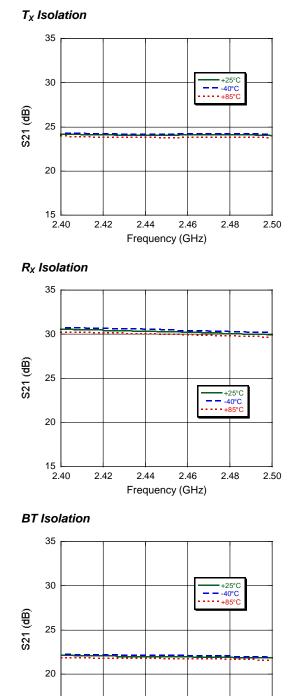


R_x Insertion Loss



BT Insertion Loss







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Frequency (GHz)

2.46

2.48

2.50

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2.44

15

2.40

2.42

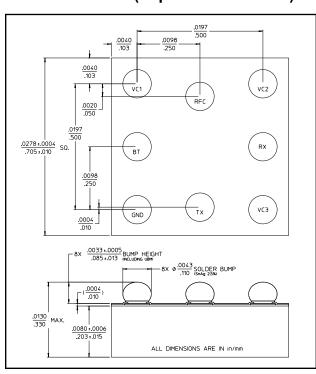
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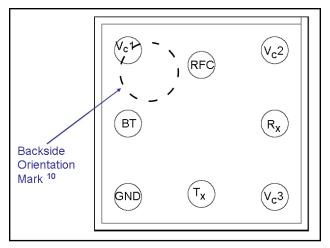
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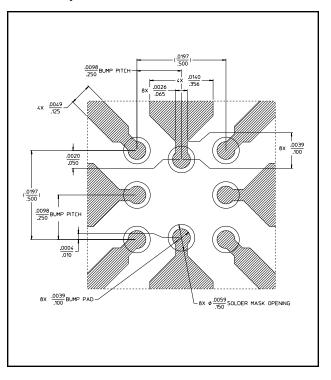
Die Dimensions (Top and Side Views)



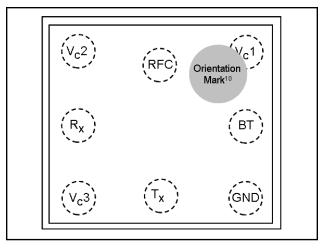
Die Bump Pad Layout - Top View (bump side up)



PCB Top Metal / Solder Mask



Die Bump Pad Layout - Bottom View (bump side down - as installed on board)



10.Orientation mark is only on material that is shipped in tape and reel. The mark is not available on die shipped on grip ring.

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